

TUSB214EVM INTv063-002 Revised: Tuesday, October 11, 2016

Revision: B

Bill Of Materials October 13,2016 9:27:28

Item	Quantity	Reference	Part	Manufacturer
1	1	C1	10uF	TDK
2	4	C2,C3,C4,C5	1uf	TDK
3	2	C6,C7	0.1uF	TDK
4	1	C8	0.01uF	TDK
5	2	D1,D2	LED Green 0805	LITE-ON INC
6	5	J1,J2,J3,J4,J5	HDR2X1 M .1	Sullins Connector Solutions
7	1	P1	USB3.0 Type B Receptacle	Würth Electronics
8	1	P2	USB3 Type A Receptacle	AMP
9	1	Q1	NPN	ON-Semi
10	1	R1		0 Panasonic
11	2	R2,R5		75 Panasonic
12	1	R3	1.7K	Panasonic
13	1	R4	3.8K	Panasonic
14	2	R6,R7	15K	Panasonic
15	2	SW2,SW3	Switch CJS-1201	Copal Electronics Inc
16	1	SW1	Switch - Push Button	Panasonic
17	1	U1	TUSB214	Texas Instruments
18	1	U2	LP5907	Texas Instruments
19	1	Label	"TUSB214EVM"	Any
20	1	Label	"INT063-002"	Any

Man. Part#	Footprint
C2012X5R1C106M085AC	cc0805
C1608X7R1A105K080AC	cc0603
C1005X5R1A104K050BA	cc0402
C0603X7R1A103K030BA	cc0201
LTST-C170KGKT	805
PEC02SAAN	
692221030100	
1932258-1	
MMBT2222ALT1G	SOT-23
ERJ-6GEY0R00V	r0805
ERJ-2RKF75R0X	r0402
ERJ-2RKF1741X	r0402
ERJ-2RKF3831X	r0402
ERJ-2RKF1502X	r0402
CJS-1201TA	cjs-1200b
EVQ-PAD05R	SW_THVT_EVQPAX05
TUSB214RWB	TI will provide
LP5907MFX-3.3/NOPD-ND	DBV_R-PDSO-G5
	Sticker text:TUSB214
	Sticker text: INT063-002 Rev A

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